IN THE VALUED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

et al. WAY 30 700h

Title:

ATOMIC LAYER DEPOSITED LaAIO3 FILMS FOR GATE DIELECTRICS

Docket No.:

1303.050US2

Serial No.: 10/789,042

Filed:

February 27, 2004

Due Date: N/A

Examiner:

Allan R. Wilson

Group Art Unit: 2815

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- X Return postcard.
- X Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (4 pgs.), and copies of 7 cited documents.
- X Authorization to charge Deposit Account 19-0743 in the amount of \$180.00 to cover the fee for consideration of Information Disclosure Statement under 97(c).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

By: // Walfack // Atty: David R. Cochra

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 25 day of May, 2006.

Name

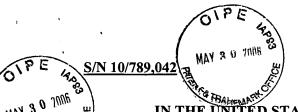
Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)

1 FW

Allan R. Wilson



Filed:

STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al. Examiner:

2815 Serial No.: 10/789,042 Group Art Unit: Docket: 1303.050US2

February 27, 2004 Title: ATOMIC LAYER-DEPOSITED LaAIO3 FILMS FOR GATE DIELECTRICS

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants hereby authorize the Commissoner to charge the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p), to Deposit Account No. 19-0743. Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

05/31/2006 RMEBRAHT 00000068 190743 10789042

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Page 2 Dkt: 1303.050US2

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938

Minneapolis, MN 55402

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Date 25 May 2006

By

David R. Cochran Reg. No. 46,632

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PTC/SB/08A(10-01)
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stant & Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 10/789,042 **Application Number** STATEMENT BY APPLICANT February 27, 2004 Filing Date as necessary) Ahn, Kie **First Named Inventor** 2815 **Group Art Unit** MAY 3 0 2006 Wilson, Allan **Examiner Name** Attorney Docket No: 1303.050US2

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Substitute for form 1449A/PTO	Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid Owle control number Complete if Known		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT	Application Number	10/789,042	
(Use as many sheets as necessary)	Filing Date	February 27, 2004	
	First Named Inventor	Ahn, Kie	
	Group Art Unit	2815	
	Examiner Name	Wilson, Allan	
Sheet 2 of 4	Attorney Docket No: 1	1303.050US2	

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Sheet 4 of 4	Attorney Docket No: 1	303.050US2	

Examiner	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited	T ²
Initials*		Publication Date	Document	

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